As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

## PARTIALLY FLUORINATED COPOLYMER BASED ON TRIFLUOROSTYRENE AND SUBSTITUTED VINYL COMPOUND AND IONIC CONDUCTIVE POLYMER MEMBRANE FORMED THERE FROM

the specification of which is attached here	eto unless the following box is checked:		
was filed on and w	as United States App	lication Number or PCT International Application Number pplicable).	
I hereby state that I have reviewed and amendment referred to above.	understand the contents of the above-identified	ed specification, including the claims,	as amended by any
I acknowledge the duty to disclose info Regulations § 1.56.	ormation which is known by me to be materia	l to patentability as defined in Title	37, Code of Federal
inventor's certificate, or § 365(a) of any P		t least one country other than the Unite	d States, listed below
NUMBER	COUNTRY	DAY/MONTH/YEAR FILED	PRIORITY CLAIMED
00-37394	Republic of Korea	30/June/2000	Yes
I hereby claim the benefit under Title 35,	United States Code § 119(e) of any United State	es provisional application(s) listed belo	w.
APPLICATION NO.		FILING DATE	

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is known by me to be material to patentability as defined in Title 37, Code of Federal Regulations § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application:

Address all correspondence to Et. M. Lee; The Law Offices of Eugene M. Lee, PLLC, 2111 vision Boulevard, Suite 1200, Arlington, Virginia 22201. Address all telephone communications to Eugene M. Lee at (703) 525-0978.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Full Name of First or Sole Inventor Hae-kyoung Kim	Signature of First	t or Sole Inventor	Date June 78 2001
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